

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

---

In re Patent Application of:  
Cha Deok DONG

Application No.: 10/720,457

Confirmation No.: 4077

Filed: November 24, 2003

Art Unit: 2822

For: METHOD FOR FORMING DEVICE  
ISOLATION FILM IN SEMICONDUCTOR  
DEVICE

---

Examiner: Michael M. Trinh

**AMENDMENT "B"**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the official action dated April 18, 2007, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 6 of this paper.